PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	PATENT SECURITY AGREEMENT

CONVEYING PARTY DATA

Name	Execution Date
HEL TECHNOLOGIES, LLC	12/31/2021

RECEIVING PARTY DATA

Name:	BLUE TORCH FINANCE LLC, AS ADMINISTRATIVE AGENT
Street Address:	150 EAST 58TH STREET
Internal Address:	18TH FLOOR
City:	NEW YORK
State/Country:	NEW YORK
Postal Code:	10155

PROPERTY NUMBERS Total: 4

Property Type	Number
Patent Number:	10180305
Patent Number:	9835412
Patent Number:	10345077
Patent Number:	10345587

CORRESPONDENCE DATA

Fax Number: (212)310-8007

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2123108000
Email: juan.arias@weil.com
Correspondent Name: ALISON FREUDMAN
Address Line 1: WEIL, GOTSHAL & MANGES LLP
Address Line 2: 767 FIFTH AVENUE
Address Line 4: NEW YORK, NEW YORK 10153

NAME OF SUBMITTER:	ALISON FREUDMAN
SIGNATURE:	/ALISON FREUDMAN/
DATE SIGNED:	04/18/2022

Total Attachments: 20
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PATENT SECURITY AGREEMENT

This PATENT SECURITY AGREEMENT (this "Patent Security Agreement") is made this 30th day of December 2021, by and among the Grantors listed on the signature pages hereof (collectively, jointly and severally, "Grantors" and each individually "Grantor"), and **BLUE TORCH FINANCE LLC**, a Delaware limited liability company ("Blue Torch"), in its capacity as administrative agent for each member of the Secured Parties (in such capacity, together with its successors and assigns in such capacity, "Agent").

W I T N E S S E T H:

WHEREAS, pursuant to that certain Financing Agreement dated as of December 30, 2021 (as amended, restated, supplemented, or otherwise modified from time to time, the "Financing Agreement") by and among **PROJECT ECHO HOLDINGS, LLC**, a Michigan limited liability company (the "Parent"), **EOTECH, LLC**, a Michigan limited liability company (together with each subsidiary of the Parent listed as a "Borrower" on the signature pages thereto and each other Person that executes a joinder agreement and becomes a "Borrower" thereunder, each a "Borrower" and collectively, the "Borrowers"), each subsidiary of any Borrower listed as a "Guarantor" on the signature pages thereto (together with the Parent and each other Person that executes a joinder agreement and becomes a "Guarantor" thereunder, each a "Guarantor" and collectively, the "Guarantors"), the lenders from time to time party thereto (each a "Lender" and collectively, the "Lenders") and Agent, the Secured Parties has agreed to make certain financial accommodations available to Borrowers from time to time pursuant to the terms and conditions thereof;

WHEREAS, the members of the Secured Parties are willing to make the financial accommodations to Borrowers as provided for in the Financing Agreement, the other Loan Documents, but only upon the condition, among others, that the Grantors shall have executed and delivered to Agent, for the benefit of the Secured Parties, that certain Security Agreement, dated as of December 30, 2021 (including all annexes, exhibits or schedules thereto, as from time to time amended, restated, supplemented or otherwise modified, the "Security Agreement"); and

WHEREAS, pursuant to the Security Agreement, Grantors are required to execute and deliver to Agent, for the benefit of the Secured Parties, this Patent Security Agreement.

NOW, THEREFORE, in consideration of the premises and mutual covenants herein contained and for other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each Grantor hereby agrees as follows:

1. DEFINED TERMS. All initially capitalized terms used but not otherwise defined herein have the meanings given to them in the Security Agreement or, if not defined therein, in the Financing Agreement, and this Patent Security Agreement shall be subject to the rules of construction set forth in Section 1(b) of the Security Agreement, which rules of construction are incorporated herein by this reference, mutatis mutandis.

2. GRANT OF SECURITY INTEREST IN PATENT COLLATERAL. Each Grantor hereby unconditionally grants, assigns, and pledges to Agent, for the benefit each member of the Secured Parties, to secure the Secured Obligations, a continuing security interest (referred to in this Patent Security Agreement as the "Security Interest") in all of such Grantor's right, title and interest in and to the following, whether now owned or hereafter acquired or arising (collectively, the "Patent Collateral"):

(a) all of its Patents and Patent Intellectual Property Licenses to which it is a party including those referred to on Schedule I;

(b) all divisionals, continuations, continuations-in-part, reissues, reexaminations, or extensions of the foregoing; and

(c) all products and proceeds of the foregoing, including any claim by such Grantor against third parties for past, present or future infringement of any Patent or any Patent exclusively licensed under any Intellectual Property License, including the right to receive damages, or right to receive license fees, royalties, and other compensation under any Patent Intellectual Property License.

3. SECURITY FOR SECURED OBLIGATIONS. This Patent Security Agreement and the Security Interest created hereby secures the payment and performance of the Secured Obligations, whether now existing or arising hereafter. Without limiting the generality of the foregoing, this Patent Security Agreement secures the payment of all amounts which constitute part of the Secured Obligations and would be owed by Grantors, or any of them, to Agent, the other members of the Secured Parties, or any of them, whether or not they are unenforceable or not allowable due to the existence of an Insolvency Proceeding involving any Grantor.

4. SECURITY AGREEMENT. The Security Interest granted pursuant to this Patent Security Agreement is granted in conjunction with the security interests granted to Agent, for the benefit of the Secured Parties, pursuant to the Security Agreement. Each Grantor hereby acknowledges and affirms that the rights and remedies of Agent with respect to the Security Interest in the Patent Collateral made and granted hereby are more fully set forth in the Security Agreement, the terms and provisions of which are incorporated by reference herein as if fully set forth herein. To the extent there is any inconsistency between this Patent Security Agreement and the Security Agreement, the Security Agreement shall control.

5. AUTHORIZATION TO SUPPLEMENT. If any Grantor shall obtain rights to any new patent application or issued patent or become entitled to the benefit of any patent application or patent for any divisional, continuation, continuation-in-part, reissue, or reexamination of any existing patent or patent application, the provisions of this Patent Security Agreement shall automatically apply thereto. Grantors shall give prompt notice in writing to Agent with respect to any such new patent rights. Without limiting Grantors' obligations under this Section, Grantors hereby authorize Agent unilaterally to modify this Patent Security Agreement by amending Schedule I to include any such new patent rights of each Grantor. Notwithstanding the foregoing, no failure to so modify this Patent Security Agreement or amend Schedule I shall in any way affect, invalidate or detract from Agent's continuing security interest in all Collateral, whether or not listed on Schedule I.

6. COUNTERPARTS. This Patent Security Agreement is a Loan Document. This Patent Security Agreement may be executed in any number of counterparts and by different parties on separate counterparts, each of which, when executed and delivered, shall be deemed to be an original, and all of which, when taken together, shall constitute but one and the same Patent Security Agreement. Delivery of an executed counterpart of this Patent Security Agreement by telefacsimile or other electronic method of transmission shall be equally as effective as delivery of an original executed counterpart of this Patent Security Agreement. Any party delivering an executed counterpart of this Patent Security Agreement by telefacsimile or other electronic method of transmission also shall deliver an original executed counterpart of this Patent Security Agreement but the failure to deliver an original executed counterpart shall not affect the validity, enforceability, and binding effect of this Patent Security Agreement.

7. CHOICE OF LAW AND VENUE, JURY TRIAL WAIVER, AND JUDICIAL REFERENCE PROVISION. THIS PATENT SECURITY AGREEMENT SHALL BE SUBJECT TO THE

PROVISIONS REGARDING CHOICE OF LAW AND VENUE, JURY TRIAL WAIVER, AND JUDICIAL REFERENCE SET FORTH IN SECTION 25 OF THE SECURITY AGREEMENT, AND SUCH PROVISIONS ARE INCORPORATED HEREIN BY THIS REFERENCE, MUTATIS MUTANDIS.

[signature page follows]

IN WITNESS WHEREOF, the parties hereto have caused this Patent Security Agreement to be executed and delivered as of the day and year first above written.

GRANTORS:

EOTECH, LLC, a Michigan limited liability company

By: _____
Name: Joseph L. Caradonna
Title: Manager

HEL TECHNOLOGIES, LLC, a Michigan limited liability company

By: _____
Name: Joseph L. Caradonna
Title: Manager

ACCEPTED AND ACKNOWLEDGED BY:

AGENT:

BLUE TORCH FINANCE LLC, a Delaware limited liability company

DocuSigned by:
By: Kevin Genda
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Name: Kevin Genda
Title: Authorized Signatory

SCHEDULE I
to
PATENT SECURITY AGREEMENT

Patents

Grantor	Country	Patent	App./Patent No.	Grant/ Filing Date
EOTech, LLC	US	AIMING SIGHT HAVING FIXED LIGHT EMITTING DIODE (LED) ARRAY AND ROTATABLE COLLIMATOR	7225578	2007-06-05
EOTech, LLC	US	FUSED THERMAL AND DIRECT VIEW AIMING SIGHT	7319557	2008-01-15
EOTech, LLC	US	LOW PROFILE HOLOGRAPHIC SIGHT AND METHOD OF MANUFACTURING SAME	7145703	2006-12-05
EOTech, LLC	Brazil	HOLOGRAPHIC WEAPON SIGHT	DI7100129-8	2012-07-31
EOTech, LLC	Mexico	HOLOGRAPHIC WEAPON SIGHT	MX/f/2011/000147	2013-02-12
EOTech, LLC	US	HOLOGRAPHIC WEAPON SIGHT	D662566	2012-06-26
EOTech, LLC	Brazil	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	112016026265-4	2015-05-11
EOTech, LLC	Canada	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	2948669	2015-05-11
EOTech, LLC	China	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	106716048	2018-08-31
EOTech, LLC	Czechia	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	3140606	2020-04-01
EOTech, LLC	Germany	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	602015049991.3	2020-04-01
EOTech, LLC	European Patent Office	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	3140606	2020-04-01

EOTech, LLC	Israel	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	248822	2015-05-11
EOTech, LLC	India	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	201617041361	2015-05-11
EOTech, LLC	Japan	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	6770950	2020-09-30
EOTech, LLC	Russian Federation	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	2677608	2019-01-17
EOTech, LLC	Sweden	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	3140606	2020-04-01
EOTech, LLC	US	INTEGRATED FILTER AND GRATING IN AN AIMING SIGHT	9482803	2016-11-01
EOTech, LLC	European Union	Rifle Scope	004238327-0002	2017-09-04
EOTech, LLC	European Union	Rifle Scope	004238327-0001	2017-09-04
EOTech, LLC	UK	Rifle Scope	90042383270001	2017-09-04
EOTech, LLC	UK	Rifle Scope	90042383270002	2017-09-04
EOTech, LLC	Japan	Rifle Scope	1598510	2018-02-26
EOTech, LLC	Japan	Rifle Scope	1598511	2018-02-26
EOTech, LLC	US	Rifle Scope	D923739	2021-06-29
EOTech, LLC	US	Rifle Scope	29/785,513	2021-05-26
EOTech, LLC	US	ENHANCED VISION SYSTEMS AND METHODS	17/390,128	2021-07-30
EOTech, LLC	US	ENHANCED VISION SYSTEMS AND METHODS	16/319,446	2017-05-04
EOTech, LLC	US	MODULAR WEAPON SIGHT ASSEMBLY	17/380,435	2021-07-20
EOTech, LLC	US	MODULAR WEAPON SIGHT ASSEMBLY	11098980	2021-08-24

EOTech, LLC	PCT	MODULAR WEAPON SIGHT ASSEMBLY	PCT/US2020/060695	2020-11-16
EOTech, LLC	US	WEAPON SIGHT WITH TAPERED HOUSING	16/690,706	2019-11-21
EOTech, LLC	PCT	WEAPON SIGHT WITH TAPERED HOUSING	PCT/US2020/060702	2020-11-16
EOTech, LLC	US	UNITARY CARRIER FOR HOLOGRAPHIC COMPONENTS	16/691,117	2019-11-21
EOTech, LLC	PCT	UNITARY CARRIER FOR HOLOGRAPHIC COMPONENTS	PCT/US2020/060707	2020-11-16
EOTech, LLC	US	TEMPERATURE STABILIZED HOLOGRAPHIC SIGHT	16/691,192	2019-11-21
EOTech, LLC	PCT	TEMPERATURE STABILIZED HOLOGRAPHIC SIGHT	PCT/US2020/060714	2020-11-16
EOTech, LLC	US	POSITION ADJUSTMENT IN HOLOGRAPHIC SIGHT	16/691,291	2019-11-21
EOTech, LLC	PCT	POSITION ADJUSTMENT IN HOLOGRAPHIC SIGHT	PCT/US2020/060719	2020-11-16
EOTech, LLC	US	WEAPON SIGHT	29/714,253	2019-11-21
HEL Technologies, LLC	Canada	HOLOGRAPHIC SPORTING/COMBAT OPTIC WITH RETICLES RECORDED AT DIFFERENT DISTANCES	2991503	2018-01-10
HEL Technologies, LLC	US	HOLOGRAPHIC SPORTING/COMBAT OPTIC WITH RETICLES RECORDED AT DIFFERENT DISTANCES	10180305	2017-11-02
HEL Technologies, LLC	US	HOLOGRAPHIC SPORTING/COMBAT OPTIC WITH RETICLES RECORDED AT DIFFERENT DISTANCES	9835412	2017-12-05
HEL Technologies, LLC	European Patent Office	HOLOGRAPHIC OPTICAL ELEMENT WITH EDGE LIGHTING	19822437.0	2019-06-18
HEL Technologies, LLC	Japan	HOLOGRAPHIC OPTICAL ELEMENT WITH EDGE LIGHTING	2020-570129	2019-06-18

HEL Technologies, LLC	Republic of Korea	HOLOGRAPHIC OPTICAL ELEMENT WITH EDGE LIGHTING	10-2021-7001121	2019-06-18
HEL Technologies, LLC	US	HOLOGRAPHIC OPTICAL ELEMENT WITH EDGE LIGHTING	10345077	2019-07-09
HEL Technologies, LLC	European Patent Office	TECHNIQUE FOR SELECTIVELY PROJECTING DIFFERENT HOLOGRAMS USING A SINGLE HOLOGRAPHIC OPTICAL ELEMENT	19822048.5	2019-06-18
HEL Technologies, LLC	Japan	TECHNIQUE FOR SELECTIVELY PROJECTING DIFFERENT HOLOGRAMS USING A SINGLE HOLOGRAPHIC OPTICAL ELEMENT	2020-570196	2019-06-18
HEL Technologies, LLC	Republic of Korea	TECHNIQUE FOR SELECTIVELY PROJECTING DIFFERENT HOLOGRAMS USING A SINGLE HOLOGRAPHIC OPTICAL ELEMENT	10-2021-7001120	2019-06-18
HEL Technologies, LLC	US	TECHNIQUE FOR SELECTIVELY PROJECTING DIFFERENT HOLOGRAMS USING A SINGLE HOLOGRAPHIC OPTICAL ELEMENT	10345587	2019-07-09
EOTech, LLC	US	SYSTEM AND METHOD OF DIGITAL FOCAL PLANE ALIGNMENT FOR IMAGER AND WEAPON SYSTEM SIGHTS	63/211,758	2021-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Unitary vacuum tube incorporating high voltage isolation	7325715	2008-02-05
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Wavelength extension for back thinned silicon image arrays	6943425	2005-09-13
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	1652237	2011-06-01

EOTech, LLC, as successor in interest to Intevac, Inc.	DE	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	60 2004 032 909.6	2011-06-01
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	1652237	2011-06-01
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	1652237	2011-06-01
EOTech, LLC, as successor in interest to Intevac, Inc.	GB	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	1652237	2011-06-01
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Backside thinning of image array devices	7005637	2006-02-28
EOTech, LLC, as successor in interest to Intevac, Inc.	US	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	7042060	2006-05-09
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	1741143	2011-01-05
EOTech, LLC, as successor in interest to Intevac, Inc.	DE	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	60 2004 030 951.6	2011-01-05
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	1741143	2011-01-05
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	1741143	2011-01-05

EOTech, LLC, as successor in interest to Intevac, Inc.	GB	BACKSIDE THINNING OF IMAGE ARRAY DEVICES	1741143	2011-01-05
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Backside imaging through a doped layer	7479686	2009-01-20
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Backthinned CMOS sensor with low fixed pattern noise	6969839	2005-11-29
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Semiconductor die attachment for high vacuum tubes	7012328	2006-03-14
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	1745506	2016-07-13
EOTech, LLC, as successor in interest to Intevac, Inc.	DE	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	602005049728.5	2016-07-13
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	1745506	2016-07-13
EOTech, LLC, as successor in interest to Intevac, Inc.	GB	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	1745506	2016-07-13
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	1745506	2016-07-13
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	3089208	2018-01-24

EOTech, LLC, as successor in interest to Intevac, Inc.	DE	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	60 2005 053 455.5	2018-01-24
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	3089208	2018-01-24
EOTech, LLC, as successor in interest to Intevac, Inc.	GB	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	3089208	2018-01-24
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	3089208	2018-01-24
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Semiconductor die attachment for high vacuum tubes	7607560	2009-10-27
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Semiconductor die attachment for high vacuum tubes	7608533	2009-10-27
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	1907159	2018-08-22
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	1907159	2018-08-22
EOTech, LLC, as successor in interest to Intevac, Inc.	GB	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	1907159	2018-08-22
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	SEMICONDUCTOR DIE ATTACHMENT FOR HIGH VACUUM TUBES	1907159	2018-08-22

EOTech, LLC, as successor in interest to Intevac, Inc.	US	Photocathode structure and operation	7531826	2009-05-12
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	PHOTOCATHODE STRUCTURE AND OPERATION	1891678	2018-10-31
EOTech, LLC, as successor in interest to Intevac, Inc.	DE	PHOTOCATHODE STRUCTURE AND OPERATION	60 2006 056 725.1	2018-10-31
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	PHOTOCATHODE STRUCTURE AND OPERATION	1891678	2018-10-31
EOTech, LLC, as successor in interest to Intevac, Inc.	GB	PHOTOCATHODE STRUCTURE AND OPERATION	1891678	2018-10-31
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	PHOTOCATHODE STRUCTURE AND OPERATION	1891678	2018-10-31
EOTech, LLC, as successor in interest to Intevac, Inc.	JP	The structure and method of use photoelectriccathode	5322635	2013-10-23
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Collimator bonding structure and method	8698925	2014-04-15
EOTech, LLC, as successor in interest to Intevac, Inc.	CA	COLLIMATOR BONDING STRUCTURE AND METHOD	2797134	2019-02-19
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	IMAGE SENSOR AND METHOD OF MAKING AN IMAGE SENSOR	2561675	2018-09-19

EOTech, LLC, as successor in interest to Intevac, Inc.	DE	IMAGE SENSOR AND METHOD OF MAKING AN IMAGE SENSOR	602011052245	2018-09-19
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	IMAGE SENSOR AND METHOD OF MAKING AN IMAGE SENSOR	2561675	2018-09-19
EOTech, LLC, as successor in interest to Intevac, Inc.	GB	IMAGE SENSOR AND METHOD OF MAKING AN IMAGE SENSOR	2561675	2018-09-19
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	IMAGE SENSOR AND METHOD OF MAKING AN IMAGE SENSOR	2561675	2018-09-19
EOTech, LLC, as successor in interest to Intevac, Inc.	JP	A coupling structure of the collimator and collimator coupling method	5798181	2015-10-21
EOTech, LLC, as successor in interest to Intevac, Inc.	IL	COLLIMATOR BONDING STRUCTURE AND METHOD	222569	2017-12-28
EOTech, LLC, as successor in interest to Intevac, Inc.	AU	COLLIMATOR BONDING STRUCTURE AND METHOD	2011289856	2015-10-15
EOTech, LLC, as successor in interest to Intevac, Inc.	IN	COLLIMATOR BONDING STRUCTURE AND METHOD	380756	2021-10-29
EOTech, LLC, as successor in interest to Intevac, Inc.	KR	COLLIMATOR BONDING STRUCTURE AND METHOD	101783594	2017-09-26
EOTech, LLC, as successor in interest to Intevac, Inc.	CA	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	2772394	2018-02-06

EOTech, LLC, as successor in interest to Intevac, Inc.	EP	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	2474034	2014-11-12
EOTech, LLC, as successor in interest to Intevac, Inc.	DE	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	60 2010 020 254.2	2014-11-12
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	2474034	2014-11-12
EOTech, LLC, as successor in interest to Intevac, Inc.	BE	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	2474034	2014-11-12
EOTech, LLC, as successor in interest to Intevac, Inc.	GB	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	2474034	2014-11-12
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	2474034	2014-11-12
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	Night-vision sensor and apparatus	2835830	2018-10-17
EOTech, LLC, as successor in interest to Intevac, Inc.	BE	Night-vision sensor and apparatus	2835830	2018-10-17
EOTech, LLC, as successor in interest to Intevac, Inc.	DE	Night-vision sensor and apparatus	602010054509.1	2018-10-17
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	Night-vision sensor and apparatus	2835830	2018-10-17

EOTech, LLC, as successor in interest to Intevac, Inc.	GB	Night-vision sensor and apparatus	2835830	2018-10-17
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	Night-vision sensor and apparatus	2835830	2018-10-17
EOTech, LLC, as successor in interest to Intevac, Inc.	JP	The cut-off wavelength faint light portable camera having a low energy	5628315	2014-11-19
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Low energy portable low-light camera with wavelength cutoff	8421012	2013-04-16
EOTech, LLC, as successor in interest to Intevac, Inc.	IL	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	218363	2018-12-20
EOTech, LLC, as successor in interest to Intevac, Inc.	AU	LOW ENERGY PORTABLE LOW-LIGHT CAMERA WITH WAVELENGTH CUTOFF	2010286372	2015-02-05
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Backside-thinned image sensor using Al2 O3 surface passivation	8975668	2015-03-10
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Image intensifier with indexed compliant anode assembly	9734977	2017-08-15
EOTech, LLC, as successor in interest to Intevac, Inc.	CA	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	2992730	2016-07-13
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17

EOTech, LLC, as successor in interest to Intevac, Inc.	LU	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	MC	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	CH	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	IE	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	MT	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	DE	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	60 2016 038 425.6	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	FR	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	GB	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	NL	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17
EOTech, LLC, as successor in interest to Intevac, Inc.	BE	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	3323138	2020-06-17

EOTech, LLC, as successor in interest to Intevac, Inc.	JP	The anode assembly having a compliant with index intensifier	6810127	2021-01-06
EOTech, LLC, as successor in interest to Intevac, Inc.	IL	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	256899	2018-01-14
EOTech, LLC, as successor in interest to Intevac, Inc.	AU	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	2016296402	2016-07-13
EOTech, LLC, as successor in interest to Intevac, Inc.	IN	IMAGE INTENSIFIER WITH INDEXED COMPLIANT ANODE ASSEMBLY	201817003257	2018-01-29
EOTech, LLC, as successor in interest to Intevac, Inc.	CA	ADAPTIVE XDR VIA RESET AND MEAN SIGNAL VALUES	3032300	2017-07-28
EOTech, LLC, as successor in interest to Intevac, Inc.	JP	The mean signal value is reset and adaptive XDR	6966798	2021-10-26
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Adaptive XDR via reset and mean signal values	10425589	2019-09-24
EOTech, LLC, as successor in interest to Intevac, Inc.	IL	ADAPTIVE XDR VIA RESET AND MEAN SIGNAL VALUES	264477	2017-07-27
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Biocular compact collimation apparatus	10197802	2019-02-05
EOTech, LLC, as successor in interest to Intevac, Inc.	CA	BIOCULAR COMPACT COLLIMATION APPARATUS	3032414	2017-07-31

EOTech, LLC, as successor in interest to Intevac, Inc.	EP	BIOCULAR COMPACT COLLIMATION APPARATUS	17835407	2017-07-31
EOTech, LLC, as successor in interest to Intevac, Inc.	JP	Compact two-collimating device	2019504917	2017-07-31
EOTech, LLC, as successor in interest to Intevac, Inc.	WO	BIOCULAR COMPACT COLLIMATION APPARATUS	2018023107	2018-02-01
EOTech, LLC, as successor in interest to Intevac, Inc.	IL	BIOCULAR COMPACT COLLIMATION APPARATUS	264529	2017-07-30
EOTech, LLC, as successor in interest to Intevac, Inc.	US	Thermally assisted negative electron affinity photocathode	10692683	2020-06-23
EOTech, LLC, as successor in interest to Intevac, Inc.	CA	THERMALLY ASSISTED NEGATIVE ELECTRON AFFINITY PHOTOCATHODE	3075509	2018-09-12
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	THERMALLY ASSISTED NEGATIVE ELECTRON AFFINITY PHOTOCATHODE	18856829	2018-09-12
EOTech, LLC, as successor in interest to Intevac, Inc.	JP	The heat assisted negative electron affinity photocathode	2020514947	2018-09-12
EOTech, LLC, as successor in interest to Intevac, Inc.	IL	THERMALLY ASSISTED NEGATIVE ELECTRON AFFINITY PHOTOCATHODE	273140	2018-09-11
EOTech, LLC, as successor in interest to Intevac, Inc.	AU	THERMALLY ASSISTED NEGATIVE ELECTRON AFFINITY PHOTOCATHODE	2018332878	2018-09-12

EOTech, LLC, as successor in interest to inventors and Intevac, Inc.	US	COMPACT PROXIMITY FOCUSED IMAGE SENSOR	16881946	2020-05-22
EOTech, LLC, as successor in interest to Intevac, Inc.	WO	COMPACT PROXIMITY FOCUSED IMAGE SENSOR	US21033948	2021-05-24
EOTech, LLC, as successor in interest to Intevac, Inc.	EP	SEE THROUGH AXIAL HIGH ORDER PRISM	18761096	2018-03-02

Patent Licenses

None.